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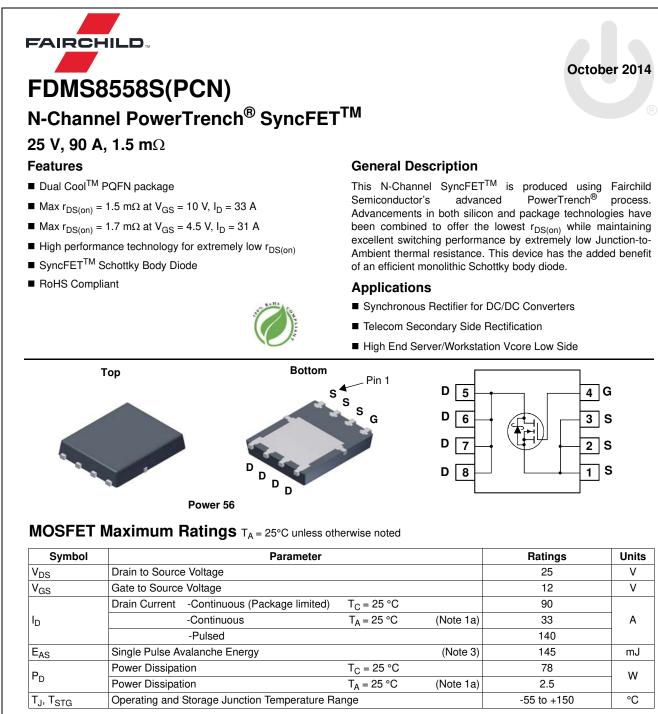


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	T _C = 25 °C		1.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	T _A = 25 °C	(Note 1a)	50	C/ W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
09OD	FDMS8558S	Power 56	13"	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
3V _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	25			V	
ΔBV _{DSS} ΔT _{.1}	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		24		mV/°C	
DSS	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			500	μA	
GSS	Gate to Source Leakage Current	$V_{GS} = +12 \text{ V/-8 V}, V_{DS} = 0 \text{ V}$			±100	nA	
	cteristics	00 200					
						N	
/ _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.1	1.4	2.2	V	
∆V _{GS(th)} ∆T _J	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-3		mV/°C	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 33 \text{ A}$		1.1	1.5	mΩ	
DS(on)	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 31 \text{ A}$		1.3	1.7		
		V_{GS} = 10 V, I_{D} = 33 A, T_{J} = 125 °C		1.6	2.1		
FS	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 33 A$		317		S	
ynamic	Characteristics						
viss	Input Capacitance			5118		pF	
oss	Output Capacitance	─ V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHz		1508		pF	
rss	Reverse Transfer Capacitance			195		pF	
Rg	Gate Resistance			0.9		Ω	
	Characteristics						
d(on)	Turn-On Delay Time			14		ns	
	Rise Time	V _{DD} = 13 V, I _D = 33 A,		8		ns	
l(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		51		ns	
((011)	Fall Time			7		ns	
2 _g	Total Gate Charge	V _{GS} = 0 V to 10 V		81		nC	
λ _g	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 13 \text{ V},$		38		nC	
) _{gs}	Gate to Source Gate Charge	I _D = 33 A		10		nC	
ggd)gd	Gate to Drain "Miller" Charge			9.7		nC	
	urce Diode Characteristics						
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	0.8		
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 33 A$ (Note 2)		0.8	1.2	V	
r	Reverse Recovery Time			35		ns	
ک _{rr}	Reverse Recovery Charge	— I _F = 33 A, di/dt = 300 A/μs		49		nC	
DTES: R_{0JA} is determ by the user's b	a) 50 °C/W when mounted on 1 in ² pad of 2 oz copper		b) 125 °C/V	by design wh V when mount n pad of 2 oz d	ted on a	etermined	

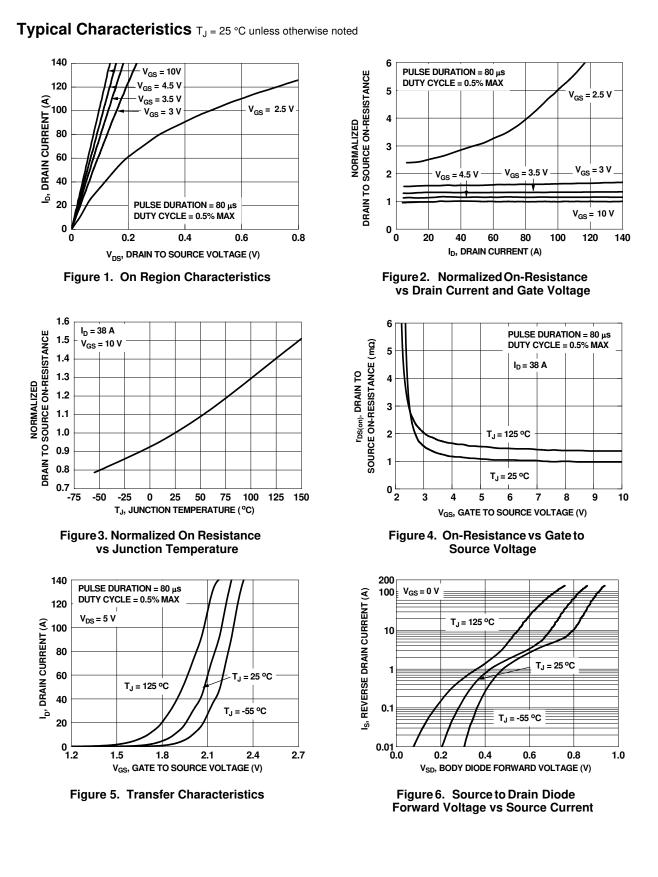
2. Pulse Test: Pulse Width < 300 $\mu \text{s},$ Duty cycle < 2.0%.

3. E_{AS} of 145 mJ is based on starting T_J = 25 °C, L = 0.9 mH, I_{AS} = 18 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 39 A.

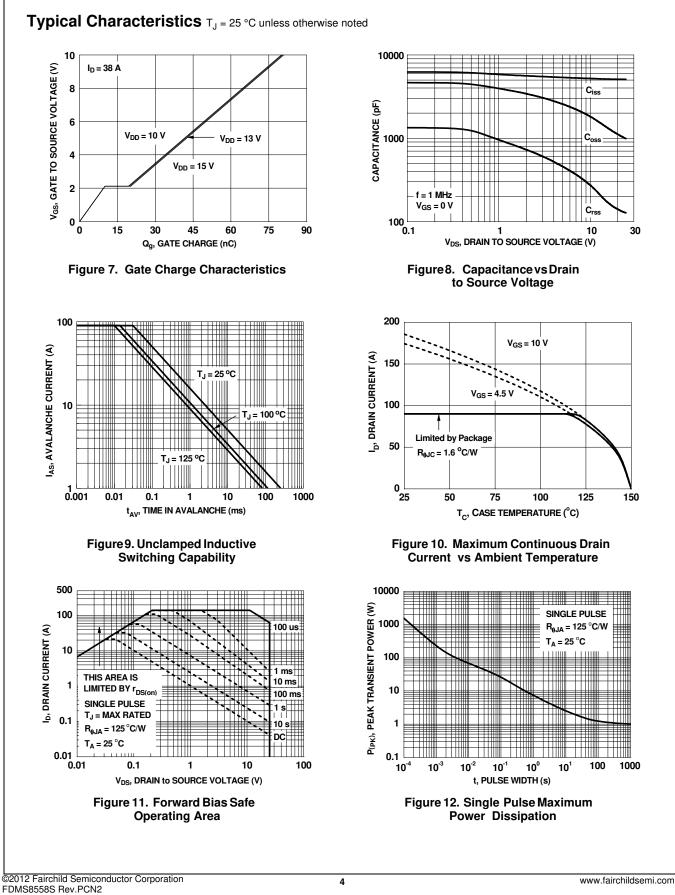
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FDMS8558S(PCN) N-Channel PowerTrench[®] SyncFETTM

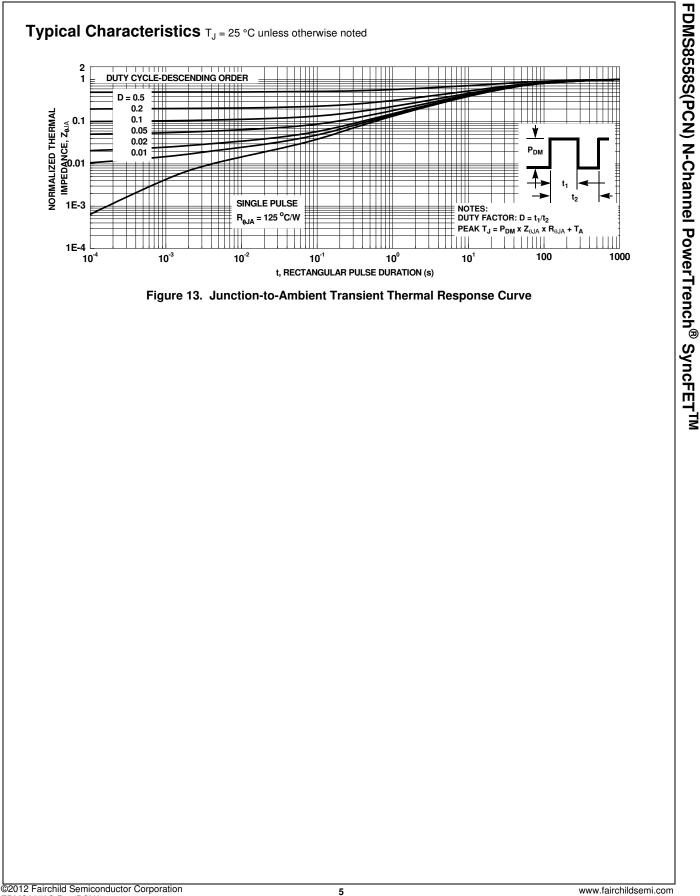
FDMS8558S(PCN) N-Channel PowerTrench[®] SyncFETTM



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FDMS8558S(PCN) N-Channel PowerTrench[®] SyncFETTM



FDMS8558S Rev.PCN2

FDMS8558S(PCN) N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8558S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

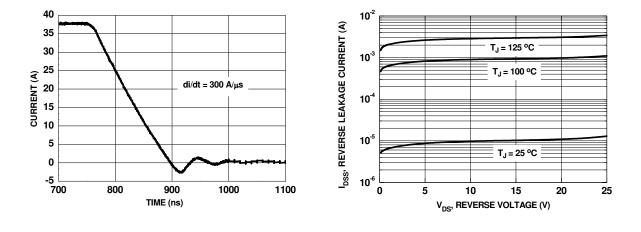
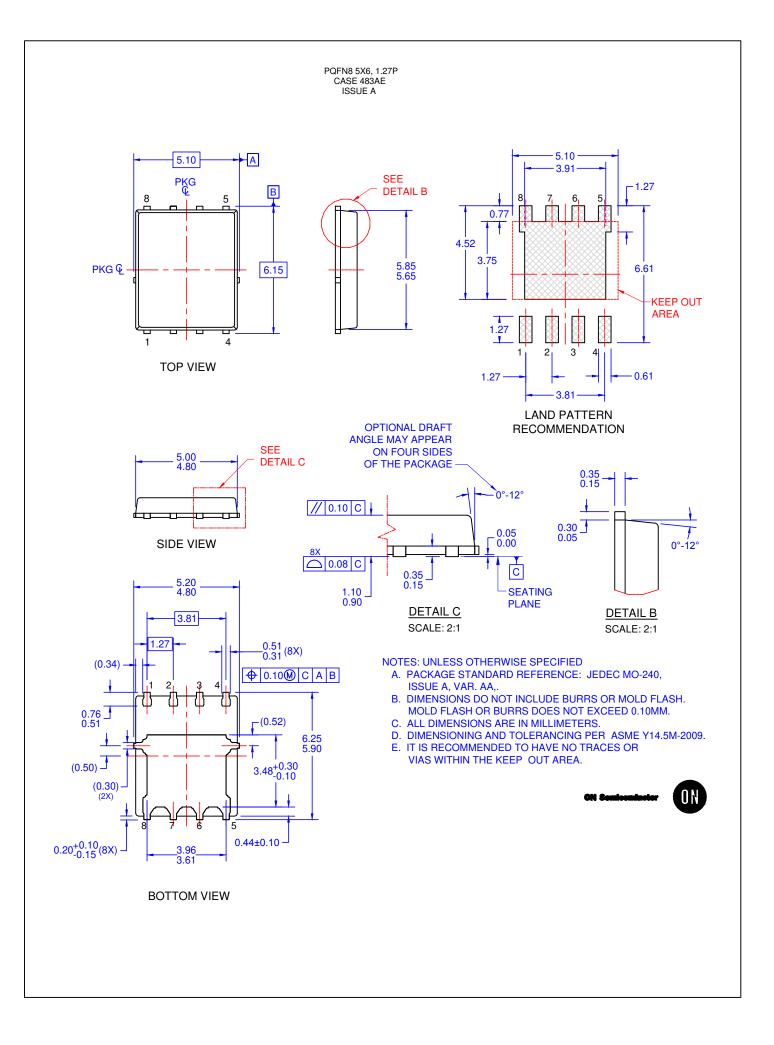


Figure 14. FDMS8558S SyncFETTM body diode reverse recovery characteristic

Figure 15. SyncFETTM body diode reverse leakage versus drain-source voltage



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